

	Type	Hits	Search Text	DBs	Time Stamp
1	BRS	213	electroplating and (dry adj etch\$3) and (etch\$3 rate) and rough\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/02/27 14:19
2	BRS	173	(electroplating and (dry adj etch\$3) and (etch\$3 rate) and rough\$5) and (via hole opening)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/02/27 14:19
3	IS&R	2452	((("361/748") or ("174/255,256,258"))).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/02/28 09:13
4	BRS	1300	((("361/748") or ("174/255,256,258"))).CCLS.) and (hole opening via)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/02/28 09:14